

TFT LCD

Specification This module uses ROHS material

() Preliminary Specification

(•) Final Specification

Title 1.50" TFT LCD

Customer	
MODEL	

SUPPLIER	B&H Korea Co., Ltd.
MODEL	BHT150TREA
Revision	Ver 1.21



SIGNATURE	DATE						
/							
/							
/							
Products Engineering Dept. B&H Korea Co., Ltd							



Table of Contents

NO.	ltem	Page
	Cover Sheet	1
	Table of Contents	2
	Record of Reversion	3
1	Features	4
2	General Specification	4
3	Input / Output Terminals	5
4	Absolute Maximum Ratings	6
5	Electrical Characteristics	7
6	Timing Chart	8
7	Optical Characteristics	10
8	Reliability	13
9	Handling Cautions	14
10	Mechanical Drawing	15
11	Packing Drawing	16



Record of Reversion

Rev	Issued Date	Description
0	Dec 28, 2011	New
0.1	Jan 25, 2012	Modify 7.2 Basic Measure Condition: Format
0.11	Mar 05, 2012	 Add White Chromaticity Max in 7.1 Delete Backlight Life Time in 5.2 Add HVDD and VVDD Current Add Left/Right and Up/Down Image in 3.1 Delete Optical System B in 7.2 Add 11. Packing Drawing
0.20	May 07, 2012	7.3 Cancel Vcom Measured Method
0.21	Jun 17, 2012	10. Mechanical Drawing: Change FPC enhanced board length form 5.0mm to 4.0mm



1 FEATURES

The 1.5"(3.86 cm) LCD module is the active matrix color TFT LCD module. LTPS (Low Temperature Poly Silicon) TFT technology is used and vertical and horizontal drivers are built on the panel. NTSC and PAL format are compatible. Horizontal scan can be from left to right or from right to left and Vertical scan can be from up to down or from down to up.

2 GENERAL SPECIFICATIONS

ltem	Description	Unit
Display Size (Diagonal)	1.5 inch (3.86cm)	
Display Type	Transmissive	
Active Area (HxV)	31.15 X 22.80	mm
Number of Dots (HxV)	490 x 240=117,600	dot
Dot Pitch (HxV)	0.0635 X 0.095	mm
Color Arrangement	RGB Delta	
Color Numbers	Full Color	
Outline Dimension (HxVxT)	37.1 x 32.7 x 3.74	mm
Weight	10	g
Surface Treatment	Anti Reflection	

* Exclude FPC and protrusions.

3 INPUT/OUTPUT TERMINALS

3.1TFT LCD Panel

Recommend Connector Type: HIROSE FH24S-0.5SH

Pin	Symbol	I/O	Description	Remark
1	NC	-	No connection (Leave this pin open)	
2	COM	Ι	Common voltage	
3	CKV1	Ι	Vertical clock 1	
4	CKV2	Ι	Vertical clock 2	
5	VVDD	Ι	Power supply for vertical driver	
6	STV	Ι	Vertical start signal	
7	XSTV	Ι	Inverted signal of STV	
8	CSV	Ι	Up / Down inverse control signal	Note 3-1
9	ENB	Ι	Enable signal	
10	XENB	Ι	Inverted signal of ENB	
11	PCD	Ι	Precharge data signal	
12	В	Ι	Video signal (B)	
13	R	Ι	Video signal (R)	
14	G	Ι	Video signal (G)	
15	VSS	Ι	VSS for vertical and horizontal driver	
16	XPCG	Ι	Inverted signal of PCG	
17	PCG	Ι	Precharge gate signal	
18	CSH	Ι	Right / Left inverse control signal	Note 3-2
19	XSTH	Ι	Inverted signal of STH	
20	STH	Ι	Horizontal start signal	
21	CKH2	Ι	Horizontal clock 2	
22	CKH1	Ι	Horizontal clock 1	
23	HVDD	Ι	Power supply for horizontal driver	
24	NC	-	No connection (Leave this pin open)	

Note 3-1: H: Normal scan,

L: Reverse scan

toppoly

toppoly



Note 3-2: H: Normal scan,

L: Reverse scan

toppoly

toppoly

3.2 Light Source

Light Source Type: LED Backlight

Recommend Connector Type: JST-ZHR-2

Pin	Symbol	Description	Remark
1	VF	LED Input Voltage	
2	V_{FS}	GND for LED Backlight	

4 ABSOLUTE MAXIMUM RATINGS

VSS=0V Item Symbol MIN MAX Unit V Power Supply for Horizontal Driver HVDD -1.0 +14 VVDD +14 V Power Supply for Vertical Driver -1.0 Common Electrode Voltage VCOM -1.0 +14 V V -1.0 +14 Horizontal Driver / Precharge Data STH, XSTH, CKH1, CKH2, Input Voltage CSH, PCG, XPCG Vertical Driver / Precharge Data STV, XSTV, CKV1, CKV2, -1.0 +14 V Input Voltage CSV, ENB, XENB Video / Precharge Data Input VG, VR, VB, VPCD -1.0 +13 V Voltage 25 Back Light Forward Current \mathbf{I}_{F} mΑ _ °C **Operating Temperature** Topr -10 +60 °C Storage Temperature -30 +80 Tstg

5 ELECTRICAL CHARACTERISTICS

5.1 Driving TFT LCD Panel

					VS	6S=0V, T	a=25 ℃
Item		Symbol	MIN	TYP	MAX	Unit	Remark
Power Supply for Ver	tical Driver	VVDD	11.7	12	12.3	V	
Power Supply for Hor	izontal Driver	HVDD	11.7	12	12.3	V	
Horizontal Driver	Low	VHIL	-0.3	0.0	0.3	V	
Input Voltage	High	VHIH	2.5	3.0	4.0	V	
Vertical Driver Input Voltage	Low	VVIL	-0.3	0.0	0.3	V	
	High	VVIH	2.5	3.0	4.0	V	
	Low	VSIL	-0.3	0.0	0.3	V	
031,037	High	VSIH	11.5	VDD	VDD	V	
Video Signal Center V	/oltage	VVC	5.0	5.2	5.4	V	Note 5-1
Video Input Voltage R	lange	VG, VR, VB	VCC-3.5		VVC+3.5	V	
Common Electrode Voltage		VCOM		VVC-0.2		V	Note 5-2
Current of Vertical Driver		IVDD		0.66		mA	
Current of Horizontal Driver		IHDD		2.9		mA	
Panel Power Consum	ption	W _P		43		mW	

Note 5-1: Video signal and precharge data signal shall be input symmetrically around VVC.

Note 5-2: Set common electrode voltage to the optimum voltage.

(1) Driving TFT LCD Panel Block Diagram





Ta=25℃

Product Specification

5.2

Driving Backlight

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	I _F		15	20	mA	
Forward Current Voltage	V_{F}	8.85	10.425	11.625	V	Note 5-3
Backlight Power Consumption	W_{BL}		156.375		mW	

Note 5-3: Backlight driving circuit is recommend as the fix current circuit.

6 TIMING CHART

6.1 Horizontal

	NTSC	PAL	1(fh)	Q(fb)	2/fb)	4(fh)	5(fh)	6(fh)	7(fh)	8(fh)	9(fh)	10(fh)	11(fh)
	Cycle(fh)	Cycle(fh)		∠(III)	S(III)								
Odd	622	636	90 E	10	6	60	0.5	25	10.5	21 5	76 5	50	22.5
Line	(t=102.2ns)	(t=100.6ns)	82.5	12	0	09	9.5	20	19.5	51.5	10.5	50	32.3
Even	622	636	01	10	6	60	0	25	10	20	75	50	20 E
Line	(t=102.2nS)	(t=100.6nS)	01	12	6	09	0	20	10	30	75	50	32.3

(1) Odd Line







7 OPTICAL CHARACTERISTICS

7.1 Optical Specification

								Ta=25 ℃
ltem		Symbol	Condition	MIN	TYP	MAX	Unit	Remarks
		Θ11		35	40			
Viewing Angles		Θ12	CR ≥ 10	35	40		Degree	Note 7-1
		Θ21		15	20			
		Θ22		50	60			
Contrast Ratio		CR	Θ=0°	100	150			Note 7-2
Response Time	Rising	Tr			17			Note 7-3
	Falling	Tf			30		ms	
Luminance (I⊧=15mA)		L		220	260		cd/m ²	Note 7-5
V-T Characteristics	V90	VT90			2.3		V	Note 7-4
	V10	VT10			1.4		V	
Chromaticity	White	XW			0.295	0.325		Note 7-6
		Уw			0.310	0.360		

7.2 Basic Measure Condition

(1) Driving voltageHVDD= 12.0V, VVDD=12.0V

VVC=5.2V, VCOM = Optimum common electrode voltage

- (2) Ambient Temperature: Ta=25°C
- (3) Testing Point: Measure in the display center point and the test angle $\theta = 0^{\circ}$
- (4) R, G, B signal input voltage VG, VR, VBVG, VR, VB=VVC ± VAC (VAC: Signal Amplitude)
- (5) LED Current: I_F =15mA.
- (6) Testing Facility: Topcon BM-5A

Environmental illumination: ≤ 10 Lux





Note 7-1: Viewing angle diagrams:



Note 7-2: Contrast Ratio:

Contrast ratio is measured in optimum common electrode voltage. The signal amplitude VAC of white image is 0.5V and black image is 3.5V.

CR = _____

Luminance with black image

Note 7-3: Definition of response time:



Note 7-4: V-T Characteristics:

Measure the relationship between video signal amplitude and transmittance. Define the voltage of 90% transmittance is V90 and the voltage of 10% transmittance is V10





Note 7-5: Luminance:

Test Point: Display Center

Test Circuit: See Section 7.2(5) Testing fix current circuit

Note 7-6: Chromaticity: The same test condition as Note 7-5.



8 REILIABILITY

No	Test Item	Condition				
1	High Temperature Operation	Ta=+60℃, 240hrs				
2	High Temperature & High Humidity Operation	Ta=+40℃, 95% RH, 240hrs				
3	Low Temperature Operation	Ta=-10℃, 240hrs				
4	High Temperature Storage (non-operation)	Ta=+80℃, 240hrs				
5	Low Temperature Storage (non-operation)	Ta=-30℃, 240hrs				
6		-30°C ↔ 80°C, 50 cycles				
	Thermal Shock (non-operation)	30 min 30 min				
7 R		C=200pF, R=0Ω;				
	Resistance to Static Electricity Discharge	Discharge: ±150V				
	(non-operation)	3 times / Terminal				
8 ;		C=150pF, R=330Ω;				
	Surface Discharge (non-operation)	Discharge: Air: ±15kV; Contact: ±8kV				
		5 times / Point; 5 Points / Panel				
9 \	Vibration (non-operation)	Frequency: 10~55Hz; Amplitude: 1.5mm				
		Sweep Time: 11min				
		Test Time: 2 hrs for each direction of X, Y, Z				
10	Shock (non-oneration)	Acceleration: 100G; Period: 6ms				
		Directions: ±X, ±Y, ±Z; Cycles: Twice				

Ta: Ambient Temperature



9 HANDLING CAUTIONS

9.1 ESD (Electrical Static Discharge) Strategy

ESD will cause serious damage of the panel, ESD strategy is very important in handling. Following items are the recommend ESD strategy

- (1) In handling LCD panel, please wear non-charged material gloves. And the conduction ring connect wrist to the earth and the conducting shoes to the earth is necessary.
- (2) The machine and working table for the panel should have ESD prohibition strategy.
- (3) In handling the panel, ionize flowing decrease the charge in the environment is necessary.
- (4) In the process of assembly the module, shield case should connect to the ground.

9.2 Environment

- (1) Working environment of the panel should in the clean room.
- (2) The front poliazer is easy damaged, handle it carefully and do not scratch it by sharp material.
- (3) Panel has polarizer protective film in the surface please remove the protection film of polarizer slowly with ionized air to prevent the electrostatic discharge.

9.3 Others

- (1) Turn off the power supply before connecting and disconnecting signal input cable.
- (2) The connection area of FPC and panel is very weak, do not handle panel only by FPC or bend FPC.
- (3) Water drop on the surface or condensation as panel power on will corrode panel electrode.
- (4) As the packing bag open, watch out the environment of the panel storage. High temperature and high humidity environment is prohibited.
- (5) When the TFT LCD module is broken, please watch out whether liquid crystal leaks out or not. If your hand touches liquid crystal, wash your hand cleanly by water and soap as soon as possible.



10 MECHANICAL DRAWING



Ver. 1.0



11 Packing Drawing

